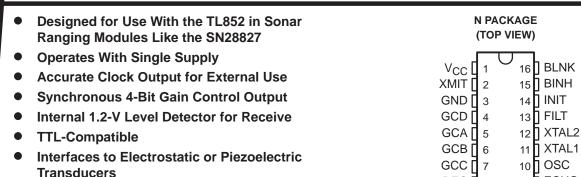
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9 ТЕСНО

REC [



### description

The TL851 is an economical digital I<sup>2</sup>L ranging control integrated circuit designed for use with the Texas Instruments TL852 sonar ranging receiver integrated circuit.

The TL851 is designed for distance measurement from six inches to 35 feet. The device has an internal oscillator that uses a low-cost external ceramic resonator. With a simple interface and a 420-kHz ceramic resonator, the device will drive a 50-kHz electrostatic transducer.

The device cycle begins when Initiate (INIT) is taken to the high logic level. There must be at least 5 ms from initial power-up ( $V_{CC}$ ) to the first initiate signal in order for all the device internal latches to reset and for the ceramic-resonator-controlled oscillator to stabilize. The device will transmit a burst of 16 pulses each time INIT is taken high.

The oscillator output (OSC) is enabled by INIT. The oscillator frequency is the ceramic resonator frequency divided by 8.5 for the first 16 cycles (during transmit) and then the oscillator frequency changes to the ceramic resonator frequency divided by 4.5 for the remainder of the device cycle.

When used with an external 420-kHz ceramic resonator, the device internal blanking disables the receive input (REC) for 3.8 ms after initiate to exclude false receive inputs that may be caused by transducer ringing. The internal blanking feature also eliminates echos from objects closer than 1.3 feet from the transducer. If it is necessary to detect objects closer than 1.3 feet, then the internal blanking may be shortened by taking the blanking inhibit (BINH) high, enabling the receive input. The blanking input (BLNK) may be used to disable the receive input and reset ECHO to a low logic level at any time during the device cycle for selective echo exclusion or for a multiple-echo mode of operation.

The device provides a synchronous 4-bit gain control output (12 steps) designed to control the gain of the TL852 sonar ranging receiver integrated circuit. The digital gain control waveforms are shown in Figure 2 with the nominal transition times from INIT listed in the Gain Control Output Table.

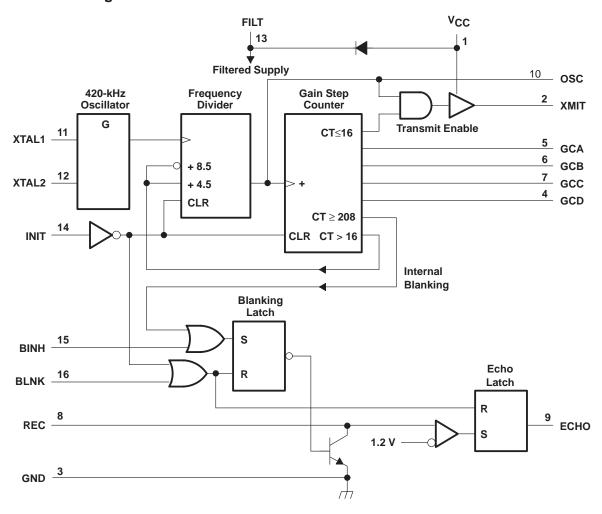
The threshold of the internal receive level detector is 1.2 V. The TL851 operates over a supply voltage range of 4.5 V to 6.8 V and is characterized for operation from 0°C to 40°C.

#### **GAIN CONTROL OUTPUT TABLE**

STEP NUMBER	GCD	GCC	GCB	GCA	TIME (ms) FROM INITIATE↑†
0	L	L	L	L	2.38 ms
1	L	L	L	Н	5.12 ms
2	L	L	L	L	7.87 ms
3	L	L	Н	Н	10.61 ms
4	L	Н	L	L	13.35 ms
5	L	Н	L	Н	16.09 ms
6	L	Н	Н	L	18.84 ms
7	L	Н	Н	Н	21.58 ms
8	Н	L	L	L	27.07 ms
9	Н	L	L	Н	32.55 ms
10	Н	L	Н	L	38.04 ms
11	Н	L	Н	Н	INIT ↓

<sup>†</sup> This is the time to the end of the indicated step and assumes a nominal 420-kHz ceramic resonator.

### functional block diagram





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# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Voltage range at any pin with respect to GND – 0.5	V to 7 V
Voltage range at any pin with respect to V <sub>CC</sub> −7 V	to 0.5 V
Continuous total dissipation at (or below) 25°C free-air temperature (see Note 1)	150 mW
Operating free-air temperature range	to 40°C
Storage temperature range – 65°C t	o 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	260°C

<sup>†</sup> Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the recommended operating conditions section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: For operation above 25°C, derate linearly at the rate of 9.2 mW/°C.

# recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V <sub>CC</sub>		4.5	6.8	V
High-level input voltage, VIH	BLNK, BINH, INIT	2.1		V
Low-level input voltage, V <sub>IL</sub>	BLNK, BINH, INIT		0.6	V
Delay time, power up to INIT high		5		ms
Operating free-air temperature, TA		0	40	°C

# electrical characteristics over recommended ranges of supply voltage and operating free-air temperature

	PARAME	TER	TEST CONDITIONS	MIN	TYP‡	MAX	UNIT
Input current		BLNK, BINH, INIT	V <sub>I</sub> = 2.1 V	1			mA
High-level output curre	ent, I <sub>OH</sub>	ECHO, OSC, GCA, GCB, GCC, GCD	V <sub>OH</sub> = 5.5 V			100	μΑ
Low-level output curre	nt, I <sub>OH</sub>	ECHO, OSC, GCA, GCB, GCC, GCD	I <sub>OL</sub> = 1.6 mA	mA 0.4		0.4	V
On-state output curren	nt	SMIT output	V <sub>O</sub> = 1 V		-140		mA
Internal blanking interv	/al	REC input		2.38§		ms	
Fraguesia during 46 s	vulae transmit naried	OSC output			49.4§		kHz
Frequency during 16-p	buise transmit period	XMIT output		1 100 0.4 -140 2.38§	KHZ		
Eroguanay ofter 16 pu	lan transmit pariod	OSC output			93.3§		kHz
Frequency after 16-pulse transmit period		XMIT output			0		KIIZ
Complete summent 1	During transmit period					260	m A
Supply current, I <sub>CC</sub>	After transmit period	I				55	mA

<sup>‡</sup> Typical values are at  $V_{CC} = 5 \text{ V}$  and  $T_A = 25^{\circ}\text{C}$ .



<sup>§</sup> These typical values apply for a 420-kHz ceramic resonator.

### schematics of inputs and outputs

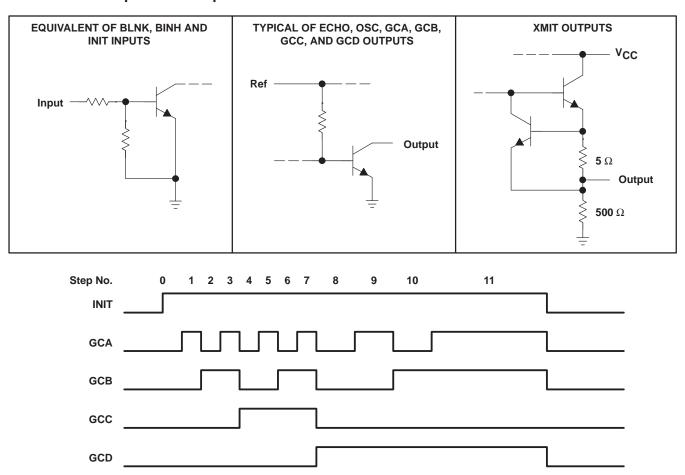


Figure 1. Digital Gain Control Waveforms

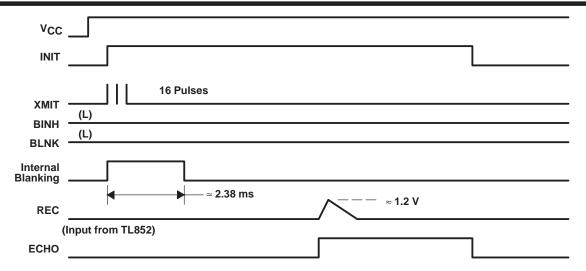


Figure 2. Example of Single-Echo-Mode Cycle When Used With the TL852 Receiver and 420-kHz Ceramic Resonator

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#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
TL851CD	Active	Production	SOIC (D)   16	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-	TL851C
TL851CD.A	Active	Production	SOIC (D)   16	40   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	See TL851CD	TL851C
TL851CDR	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-	TL851C
TL851CDR.A	Active	Production	SOIC (D)   16	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	See TL851CDR	TL851C
TL851CN	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	-	TL851CN
TL851CN.A	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	See TL851CN	TL851CN
TL851CNE4	Active	Production	PDIP (N)   16	25   TUBE	Yes	NIPDAU	N/A for Pkg Type	See TL851CN	TL851CN

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



# **PACKAGE OPTION ADDENDUM**

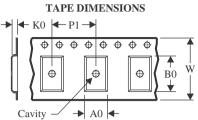
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# **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

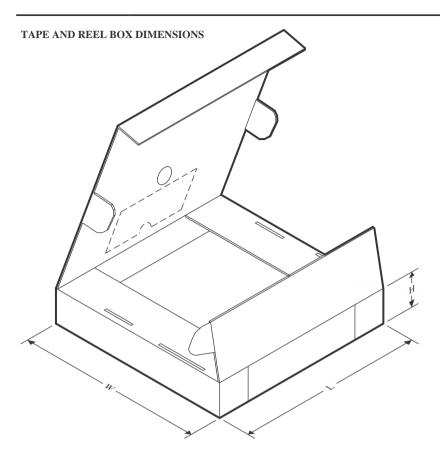
#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL851CDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

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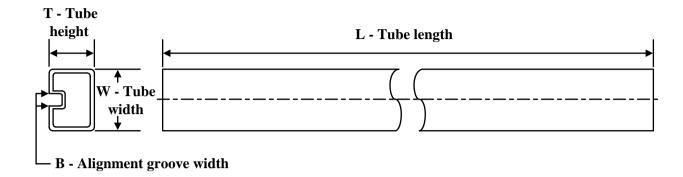
#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
TL851CDR	SOIC	D	16	2500	350.0	350.0	43.0	

# **PACKAGE MATERIALS INFORMATION**

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### **TUBE**



#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
TL851CD	D	SOIC	16	40	505.46	6.76	3810	4
TL851CD.A	D	SOIC	16	40	505.46	6.76	3810	4
TL851CN	N	PDIP	16	25	506	13.97	11230	4.32
TL851CN.A	N	PDIP	16	25	506	13.97	11230	4.32
TL851CNE4	N	PDIP	16	25	506	13.97	11230	4.32

# D (R-PDS0-G16)

### PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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